

# 13/B 2813  
10/14/03  
Mollish



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Chakravarthi et al.

Docket No.: TI-33161

Serial No.: 10/020,813

Art Unit: 2813

Filed: 12/12/01

Examiner: Huynh, Yennhu

Title: Fabrication of Ultra Shallow Junctions From a Solid Source With Fluorine Implantation

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AMENDMENT UNDER 37 CFR 1.111

October 2, 2003

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)  
I hereby certify that the above correspondence is being deposited  
with the U.S. Postal Service on  
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Karen Vertz 10-2-03  
Karen Vertz Date

In response to the Office Action, dated 08/01/2003, in the above-identified patent application, please make the following amendments. They are respectfully submitted as a full and complete response to that Action. Charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.